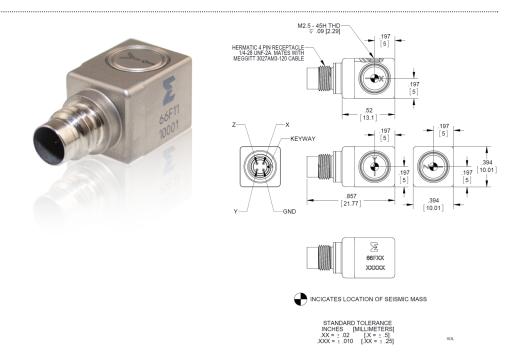


### Endevco®

# **TEDS accelerometer** Model 66F50 / F11 / F12



Endevco model 66FXX is a miniature triaxial piezoelectric accelerometer with integral hybrid electronics with transducer electronic data sheet (TEDS) capability. The accelerometer is packaged in a 10 by 10 by 13 mm case of welded titanium construction. One of the key design characteristics is the low unit-to-unit phase deviation at low frequency, ideal for modal analysis of large rigid bodies.

Model 66FXX features Endevco's Piezite crystal elements, which exhibit excellent output stability over time. This accelerometer incorporates three stand-alone, low noise internal hybrid charge converters, each operating in a twowire system. Its low impedance voltage outputs are connected to the same cables that supply the required constant current power. TEDS contains sensor specific information which can dramatically reduce set-up time in multichannel measurements. TEDS enables the signal conditioner to communicate digitally with the accelerometer's TEDS, compliant to IEEE P1451.4.

The model number suffix identifies the range and sensitivity, where 66F50 indicates a 5 mV/g sensitivity, 1000 g range unit, 66F11 indicates a 10 mV/g sensitivity, 500 g range unit, and 66F12 indicates a 100 mV/g sensitivity, 50 g range unit.

This product is fully compliant to the European Union's Low Voltage Directive, 2006/95/EC and EMC Directive 2004/108/EC and is eligible to bear the CE Mark.

### Key features

- Triaxial IEPE accelerometer
- IEEE P1451.4 TEDS v0.9
- Small, lightweight
- Single connector, cable
- Hermetically sealed
- Three sensitivity options available – 5, 10 and 100 mV/g
- 66F50-R, 66F11-R, 66F12-R available as replacement sensor

### **ENDEVCO** www.endevco.com Tel: +1 (866) ENDEVCO [+1 (866) 363-3826]

Piezoelectric accelerometers | Piezoresistive accelerometers | IEPE accelerometers | Variable capacitance accelerometers | Piezoresistive pressure sensors | Piezoelectric pressure sensors | High intensity microphones | Inertial sensors | Signal conditioners and supportive instrumentation | Cable assemblies



## Endevco®

# **TEDS accelerometer** Model 66F50 / F11 / F12

# **Specifications**

The following performance specifications conform to ISA-RP-37.2 (1964) and are typical values, referenced at +75°F (+24°C) and 100 Hz, unless otherwise noted. Calibration data, traceable to National Institute of Standards and Technology (NIST), is supplied.

Dynamic characteristics	Units	66F50	66F11	66F12	
Range	g	±1000	±500	±50	
Voltage sensitivity	5				
Nominal	mV/g	5	10	100	
Minimum	mV/g	4	8	80	
Maximum	mV/g	6	12	120	
Frequency response	5				
Resonance frequency					
Typical	kHz	55	60	45	
Minimum	kHz	50	55	40	
Amplitude response [1]					
±5%, z- and y-axis	Hz	1 to 4000	1 to 10000	3 to 8000	
±5%, x-axis	Hz	1 to 4000	1 to 8000	3 to 6000	
±1 dB, z- and y-axis	Hz	0.4 to 7000	0.4 to 14000	1.5 to 10000	
±1 dB, x-axis	Hz	0.4 to 7000	0.4 to 11000	1.5 to 8000	
±3 dB, z- and y-axis	Hz	0.2 to 12000	0.2 to 24000	0.7 to 15000	
±3 dB, x-axis	Hz	0.2 to 12000	0.2 to 20000	0.7 to 14000	
Phase response					
<5°	Hz	3 to 1000	3 to 1500	10 to 1500	
Sensitivity deviation over temperature					
At -67°F (-55°C)	%	8	-4	-3.5	
At +257°F (+125°C)	%	-10	7	4.5	
Transverse sensitivity	%		, <5		
Amplitude linearity	%		<1		
Amparade anearity	/0				
Electrical characteristics					
Output polarity		Acceleration in the	e direction of the arrow produces pos	tive output	
DC output bias voltage [2]		, accordition in the	produces pos		
Room temperature, +75°F (+24°C)	Vdc	+11.3 to 14.0	+11.3 to +14.0	+11.3 to +14.0	
-67°F to +257°F (-55°C to +125°C)	Vdc	+8 to +16	+7.5 to +16	+7.5 to +16	
Output impedance					
2 – 3 mA	Ω		<300		
4 – 20 mA	Ω		<100		
Noise floor	14		.100		
Broadband					
0.5 Hz to 10000 Hz	mg rms	6	0.8	0.4	
Spectral	ing inis	<u>U</u>	0.0	0.4	
1 Hz	mg / √Hz	5	0.5	0.3	
10 Hz	mg/vHz	0.8	0.08	0.05	
	mg/vHz mg/vHz	0.12	0.08	0.05	
11111 H 7				0.01	
100 Hz				0.004	
1000 Hz	mg / √Hz mg / √Hz	0.04	0.006	0.004	
1000 Hz Grounding		0.04		0.004	
1000 Hz Grounding Power requirements	mg⊄/ √Hz	0.04	0.006 I ground is connected to the case	0.004	
1000 Hz Grounding Power requirements Supply voltage	mg / √Hz Vdc	0.04	0.006 I ground is connected to the case +20 to +30 [3]	0.004	
1000 Hz Grounding Power requirements Supply voltage Supply current	mg⊄√Hz Vdc mA	0.04	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4]	0.004	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5]	mg / √Hz Vdc mA sec	0.04 Signa	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6]	mg⊄√Hz Vdc mA	0.04	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000	0.004	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device	mg /√Hz Vdc mA sec ms	0.04 Signa	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device	mg /√Hz Vdc mA sec ms	0.04 Signa	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device	mg /√Hz Vdc mA sec ms	0.04 Signa	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range	mg / √Hz Vdc mA sec ms	0.04 Signa	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating	mg / √Hz Vdc mA sec ms °F (°C)	0.04 Signa	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125]		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication	mg / √Hz Vdc mA sec ms	0.04 Signa	0.006 l ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85]		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity	mg / √Hz Vdc mA sec ms °F (°C) °F (°C)	0.04 Signa	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7]	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk	0.04 Signa	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000		
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shack limit [8]	mg / √Hz Vdc mA sec ms "F (°C) °F (°C) g pk g pk	0.04 Signa	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed		
1000 Hz Grounding Power requirements Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk g pk g pk eq.g/µstrain	0.04 Signa 1000	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 10000	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity	mg / √Hz Vdc mA sec ms *F (°C) °F (°C) g pk g pk g pk eq. g/µstrain equiv. g pk/°F	0.04 Signa 1000 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 10000 0.005	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk g pk g pk eq.g/µstrain	0.04 Signa 1000	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 10000	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration timit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics	mg / √Hz Vdc mA sec ms *F (°C) °F (°C) g pk g pk g pk eq. g/µstrain equiv. g pk/°F	0.04 Signa 1000 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <0 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq.g/µstrain equiv.g pk/°F equiv g/Gauss	0.04 Signa 1000 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions	mg / √Hz Vdc mA sec ms *F (°C) °F (°C) g pk g pk g pk eq. g/µstrain equiv. g pk/°F	0.04 Signa 1000 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0]	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration timit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq.g/µstrain equiv.g pk/°F equiv g/Gauss	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 (5.0) Titanium, commercially pure	2000	
1000 Hz Grounding Power requirements Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9]	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq.g/µstrain equiv.g pk/°F equiv g/Gauss	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Titanium, commercially pure n Microtech-style, side mounted	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting [10]	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq.g/µstrain equiv.g pk/°F equiv g/Gauss oz (gram)	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Fitanium, commercially pure n Microtech-style, side mounted M2.5 thread	2000	
1000 Hz Grounding Power requirements Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9]	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq.g/µstrain equiv.g pk/°F equiv g/Gauss	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Titanium, commercially pure n Microtech-style, side mounted	2000	
1000 Hz Grounding Power requirements Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting [10] Mounting torque	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq.g/µstrain equiv.g pk/°F equiv g/Gauss oz (gram)	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Fitanium, commercially pure n Microtech-style, side mounted M2.5 thread	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting [10] Mounting torque Calibration data supplied, each axis	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq. g/µstrain equiv. g pk/°F equiv g/Gauss oz (gram) Lbf-in (Nm)	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Fitanium, commercially pure n Microtech-style, side mounted M2.5 thread	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting torque Calibration data supplied, each axis Sensitivity	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq. g/µstrain equiv. g pk/°F equiv g/Gauss oz (gram) Lbf-in (Nm) mV/g	0.04 Signa 1000 -0.0003 0.005 0.00014	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Fitanium, commercially pure n Microtech-style, side mounted M2.5 thread	2000	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting [10] Mounting torque Calibration data supplied, each axis Sensitivity Transverse sensitivity, maximum	mg / √Hz Vdc mA sec ms °F(°C) °F(°C) g pk eq. g/µstrain equiv. g pk/°F equiv g/Gauss oz (gram) Lbf-in (Nm) mV/g %	0.04 Signa 1000 -0.0003 0.005 0.00014 - 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Fitanium, commercially pure n Microtech-style, side mounted M2.5 thread 10 [1.1]	2000 0.002 0.00014	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting [10] Mounting torque Calibration data supplied, each axis Sensitivity Transverse sensitivity, maximum Frequency response, y- and z-axis	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq. g/µstrain equiv. g pk/°F equiv g/Gauss oz (gram) Lbf-in (Nm) mV/g %	0.04 Signa 1000 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Titanium, commercially pure n Microtech-style, side mounted M2.5 thread 10 [1.1] 20 Hz to 10000 Hz	2000 0.002 0.00014 20 Hz to 8000 Hz	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting torque Calibration data supplied, each axis Sensitivity Transverse sensitivity, maximum Frequency response, x-axis	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq. g/µstrain equiv. g pk/°F equiv g/Gauss oz (gram) Lbf-in (Nm) mV/g % %	0.04 Signa 1000 -0.0003 0.005 0.00014 - 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 (-55 to +125) +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Fitanium, commercially pure n Microtech-style, side mounted M2.5 thread 10 [1.1]	2000 0.002 0.00014	
1000 Hz Grounding Power requirements Supply voltage Supply current Warm-up time [5] Recovery time [6] Digital communication (TEDS) device Environmental characteristics Temperature range Operating TEDS communication Humidity Sinusoidal vibration limit [7] Shock limit [8] Base strain sensitivity at 250µ strain Thermal transient sensitivity Electromagnetic noise Physical characteristics Dimensions Weight Case material Connector [9] Mounting [10] Mounting torque Calibration data supplied, each axis Sensitivity Transverse sensitivity, maximum Frequency response, y- and z-axis	mg / √Hz Vdc mA sec ms °F (°C) °F (°C) g pk g pk eq. g/µstrain equiv. g pk/°F equiv g/Gauss oz (gram) Lbf-in (Nm) mV/g %	0.04 Signa 1000 	0.006 I ground is connected to the case +20 to +30 [3] +2 to +20 [4] <20 1000 DS2431X+u -67 to +257 [-55 to +125] +32 to +185 [0 to 85] Hermetically sealed 1000 0.005 0.00023 See outline drawing 0.17 [5.0] Titanium, commercially pure n Microtech-style, side mounted M2.5 thread 10 [1.1] 20 Hz to 10000 Hz	2000 0.002 0.00014 20 Hz to 8000 Hz	



## Endevco®

# **TEDS accelerometer** Model 66F50 / F11 / F12

#### Accessories

Product	Description	66FXX	66FXX-R
3027AM3-120	Triaxial cable +85°C, 3 BNCs at instrumentation end, 10 feet [11]	Included	Optional
EH755	Screw, cap, hex soc, M2.5 – 0.45 x 6mm	Included	Included
EH761	Screw, set, hex soc, M2.5 – 0.45 x 6 mm	Included	Included
32279	Mounting wax	Included	Optional
133	Signal conditioner	Optional	Optional
C-003-CA-005-0120	General purpose triaxial cable +200°C, 3 BNCs at instrumentation end, 10 feet	Optional	Optional

#### Notes

- 1. Due to mounting method, a reverse polarity will show on the x-axis calibration certificate. The x-axis 5% upper corner may be lower by no more than 20% from the z-axis.
- 2. 22 Vdc minimum must be available to the accelerometer to ensure full scale operation at the temperature extremes.
- 3. Supply voltage requirement of 20V 30V at -55°C to +100°C, 23V 30V at -55°C to +125°C.
- 4. Supply current requirement of 2mA 20mA at -55°C to +100°C, 2mA 10mA at -55°C to +125°C.
- 5. DC bias within 10% of final value.
- 6. Time interval between the moment the sensor is saturated and the moment bias returns within 10% of final value.
- 7. Destructive limit.
- Destructive limit. Shock is a one-time event. Shock pulses of short duration may excite transducer resonance. Shock level above the sinusoidal vibration limit may produce temporary zero shift that will result in erroneous velocity or displacement data after integration.
- 9. Microtech DR-4S-4 receptacle mates with Endevco model 3027AM3-ZZZ and model C-003-XX-YYY-ZZZZ cables.
- 10. Be careful not to apply abusive forces when removing the accelerometer from a structure. Hammer taps and wrench "snaps" often impart permanent damage to the case and internal sensors.
- 11. Supplied cable assembly, the 3027AM3-120, is only rated for use up to only +185°F (+85°C). Alternate cable should be used in applications where the accelerometer is used near its upper temperature extreme, +257°F (+125°C).
- 12. Maintain high levels of precision and accuracy using Meggitt's factory calibration services. Call Meggitt's inside sales force at 866-ENDEVCO for recommended intervals, pricing and turn-around time for these services as well as for quotations on our standard products.

#### Contact

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Piezoelectric accelerometers | Piezoresistive accelerometers | IEPE accelerometers | Variable capacitance accelerometers | Piezoresistive pressure sensors | Piezoelectric pressure sensors | High intensity microphones | Inertial sensors | Signal conditioners and supportive instrumentation | Cable assemblies